

62mm Half Bridge IGBT Module

$V_{CES} = 1700V$, $I_C = 400A$, $V_{CE(sat)} = 2.05V$

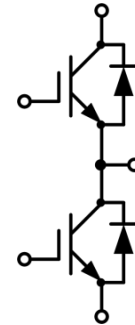
Features

- 1700V Trench/Field Stop Technology
- Low switching losses
- V_{cesat} has a positive temperature coefficient



Applications

- Power Converters
- Uninterruptible power supplies
- Servo Drives
- Inverter



IGBT, Inverter Maximum Ratings

Parameter	Symbol	Test Condition	Value	Unit
Collector-Emitter voltage	V_{CES}	$T_{vj}=25^{\circ}C$	1700	V
Continuous DC collector current	$I_{C\ nom}$	$T_C=80^{\circ}C$, $T_{vj\ max}=150^{\circ}C$	400	A
Repetitive peak collector current	I_{CRM}	$t_p=1ms$	800	
Gate-Emitter voltage	V_{GE}		± 20	V

Characteristics Values

Parameter	Symbol	Test Condition	Value			Unit
			Min.	Typ.	Max.	
Collector-Emitter saturation voltage	V_{CESat}	$V_{GE}=15V$, $I_C=400A$ $V_{GE}=15V$, $I_C=400A$ $V_{GE}=15V$, $I_C=400A$	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	2.05 2.45 2.55	2.45	V
Gate-Emitter threshold voltage	$V_{GE(th)}$	$I_C=16mA$, $V_{GE}=V_{CE}$	$T_{vj}=25^{\circ}C$	5.20	5.80	6.40
Internal gate resistor	R_{Gint}			1.00		Ω
Input capacitance	C_{ies}	$f=1MHz$, $V_{CE}=25V$, $V_{GE}=0V$	$T_{vj}=25^{\circ}C$	51.20		nF
Reverse transfer capacitance	C_{res}			0.34		
Collector-Emitter cut-off current	I_{CES}	$V_{CE}=1700V$, $V_{GE}=0V$	$T_{vj}=25^{\circ}C$		1	mA
Gate-Emitter leakage current	I_{GES}	$V_{CE}=0V$, $V_{GE}=20V$	$T_{vj}=25^{\circ}C$		400	nA
Turn-on delay time	t_{don}	$I_C=400A$, $V_{CE}=900V$ $V_{GE}=\pm 15V$, $R_G=1\Omega$ (inductive load)	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$ $T_{vj}=150^{\circ}C$	139 180 185		ns
Rise time	t_r	$I_C=400A$, $V_{CE}=900V$ $V_{GE}=\pm 15V$, $R_G=1\Omega$	$T_{vj}=25^{\circ}C$ $T_{vj}=125^{\circ}C$	41 54		

		(inductive load)	$T_{vj}=150^{\circ}\text{C}$		56		
Turn-off delay time	$t_{d\ off}$	$I_C=400\text{A}, V_{CE}=900\text{V}$ $V_{GE}=\pm 15\text{V}, R_G=1\Omega$ (inductive load)	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$		260 321 336		ns
Fall time	t_f	$I_C=400\text{A}, V_{CE}=900\text{V}$ $V_{GE}=\pm 15\text{V}, R_G=1\Omega$ (inductive load)	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$		303 521 554		
Turn-on energy loss per pulse	E_{on}	$I_C=400\text{A}, V_{CE}=900\text{V}$ $di/dt=5600\text{A}/\mu\text{s}(T_{vj}=150^{\circ}\text{C})$ $V_{GE}=\pm 15\text{V}, R_G=1\Omega$ (inductive load)	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$		67.5 99.0 107.3		mJ
Turn-off energy loss per pulse	E_{off}	$I_C=400\text{A}, V_{CE}=900\text{V}$ $dv/dt=6400\text{V}/\mu\text{s}(T_{vj}=150^{\circ}\text{C})$ $V_{GE}=\pm 15\text{V}, R_G=1\Omega$ (inductive load)	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$		48.2 75.6 80.6		
SC data	ISC	$V_{GE}\leq 15\text{V}, V_{CE}=1000\text{V}$ $V_{CEmax}=V_{CES}-L_{sCE}\cdot di/dt,$ $t_p\leq 10\mu\text{s}$	$T_{vj}=125^{\circ}\text{C}$		2200		A
Thermal resistance, junction to case	R_{thJC}	per IGBT				0.058	K/W
Temperature under switching conditions	$T_{vj\ op}$			-40		150	$^{\circ}\text{C}$

Diode, Inverter Maximum Ratings

Parameter	Symbol	Test Condition	Value	Unit
Repetitive peak reverse voltage	V_{RRM}	$T_{vj}=25^{\circ}\text{C}$	1700	V
Continuous DC forward current	I_F		400	A
Repetitive peak forward current	I_{FRM}	$t_p=1\text{ms}$	800	A
I^2t -value	I^2t	$t_p=10\text{ms}, \sin 180^{\circ}, T_{vj}=125^{\circ}\text{C}$	17000	A^2s

Characteristics Values

Parameter	Symbol	Test Condition	Value			Unit	
			Min.	Typ.	Max.		
Forward voltage	V_F	$I_F=400\text{A}, V_{GE}=0\text{V}$ $I_F=400\text{A}, V_{GE}=0\text{V}$ $I_F=400\text{A}, V_{GE}=0\text{V}$	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$		1.80 2.00 2.05	2.20 V	
Peak reverse recovery current	I_{RM}	$I_F=400\text{A}$ $-di_F/dt=7300\text{A}/\mu\text{s}(T_{vj}=150^{\circ}\text{C})$ $V_R=900\text{V}, V_{GE}=-15\text{V}$	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$		541 469 456	A	
Recovered charge	Q_r	$I_F=400\text{A}$ $-di_F/dt=7300\text{A}/\mu\text{s}(T_{vj}=150^{\circ}\text{C})$ $V_R=900\text{V}, V_{GE}=-15\text{V}$	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$		91 143 158	$^{\circ}\text{C}$	
Reverse recovered energy	E_{rec}	$I_F=400\text{A}$ $-di_F/dt=7300\text{A}/\mu\text{s}(T_{vj}=150^{\circ}\text{C})$ $V_R=900\text{V}, V_{GE}=-15\text{V}$	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=125^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$		49.6 83.6 93.1	mJ	
Thermal resistance, junction to case	R_{thJC}	per diode				0.099	K/W
Temperature under switching conditions	$T_{vj\ op}$			-40		150	$^{\circ}\text{C}$

Characteristics Values(Module)

Parameter	Symbol	Test Condition	Value			Unit
Isolation test voltage	V _{ISOL}	Rms, f=50Hz, t=1min	4000			V
Internal isolation			Al ₂ O ₃			
Storage temperature	T _{stg}		-40		125	°C
Mounting torque for module mounting	M		3.0		6.0	Nm
Weight	W			320		g

Typical Characteristics

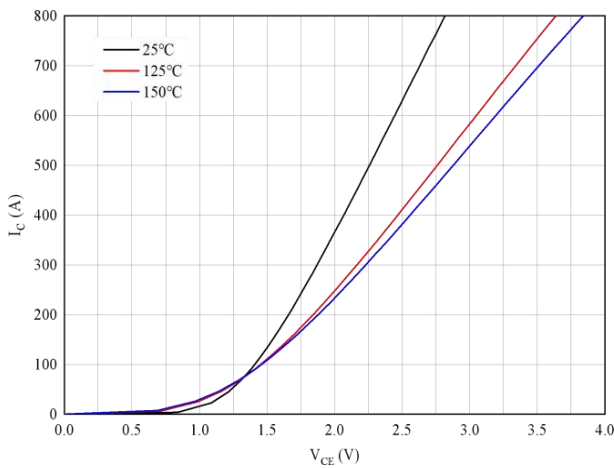


Fig 1. Typical output characteristics($V_{GE}=15V$)

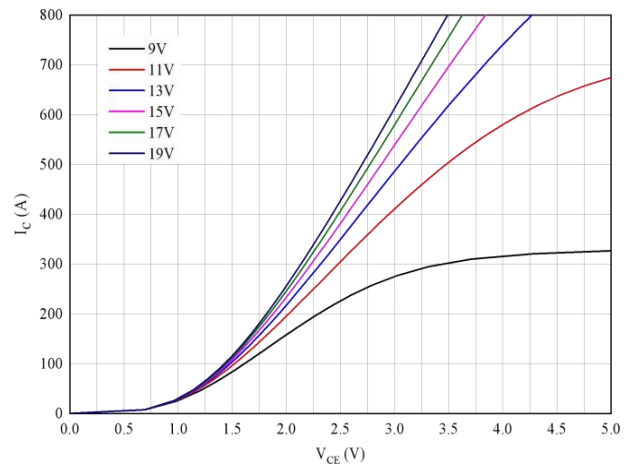


Fig 2. Typical output characteristics ($T_{vj}=150^{\circ}C$)

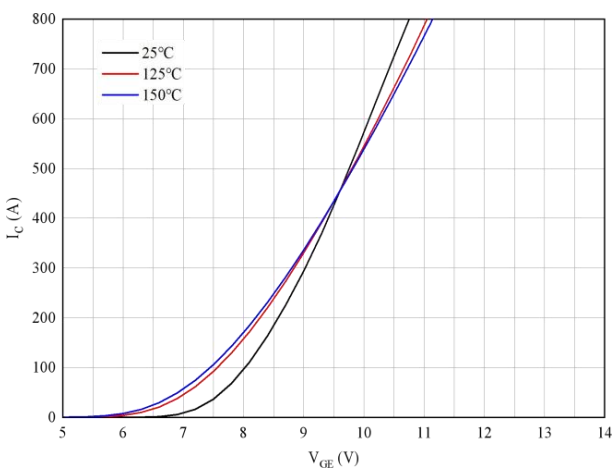


Fig 3. Typical transfer characteristic($V_{CE}=20V$)

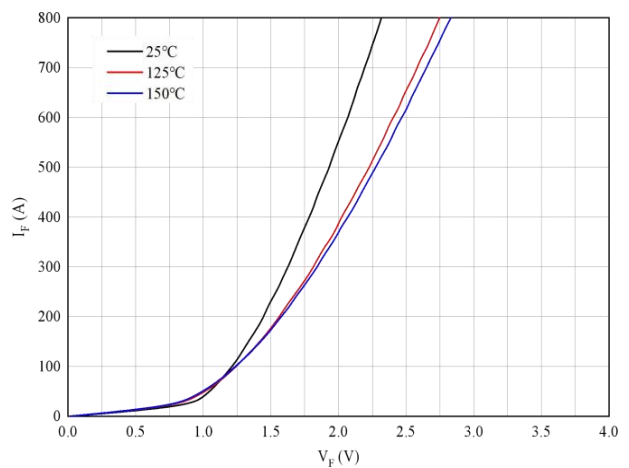
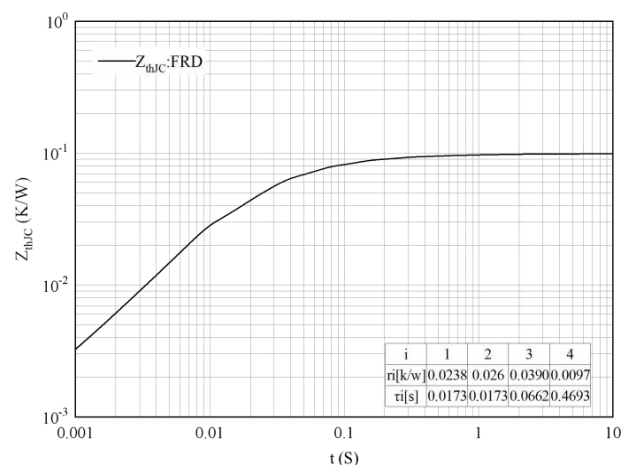
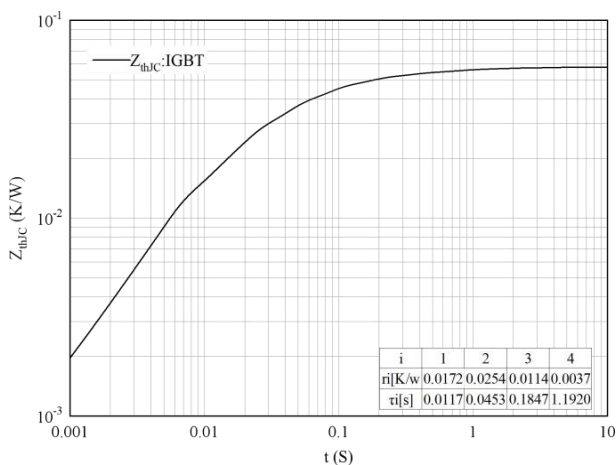
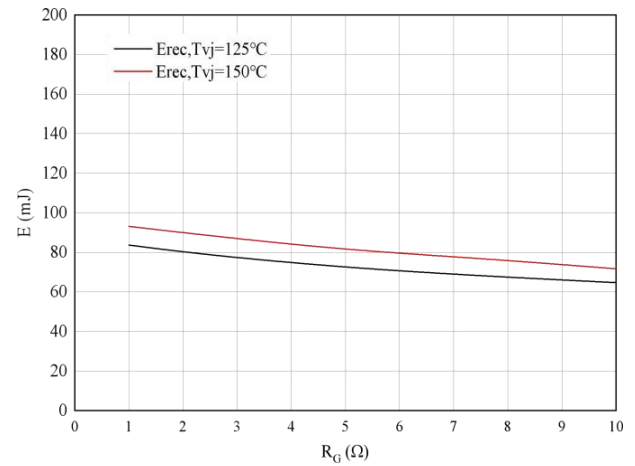
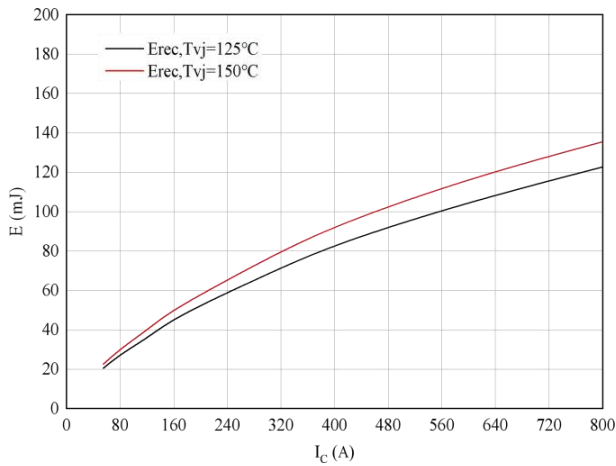
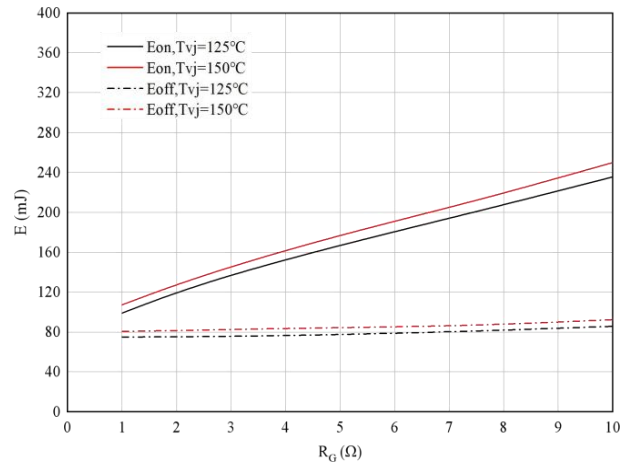
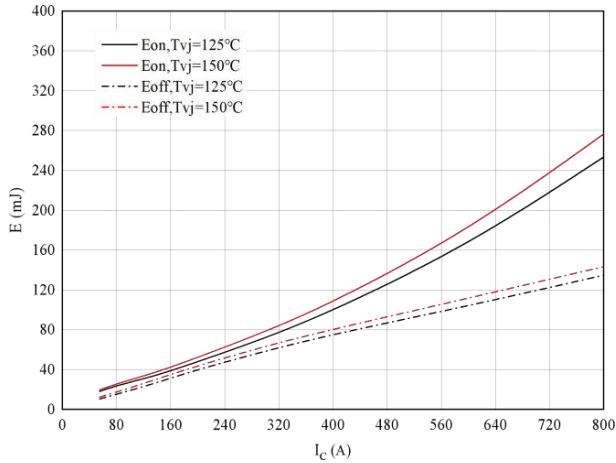


Fig 4. Forward characteristic of Diode



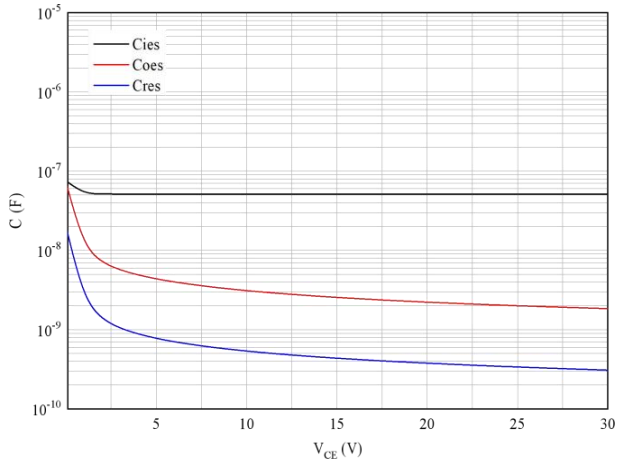
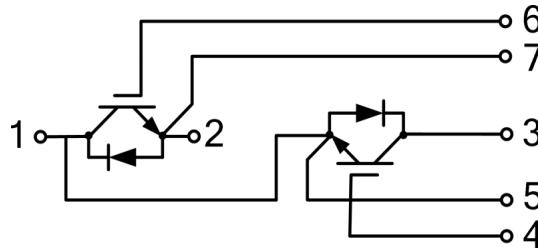
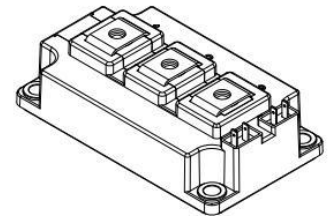
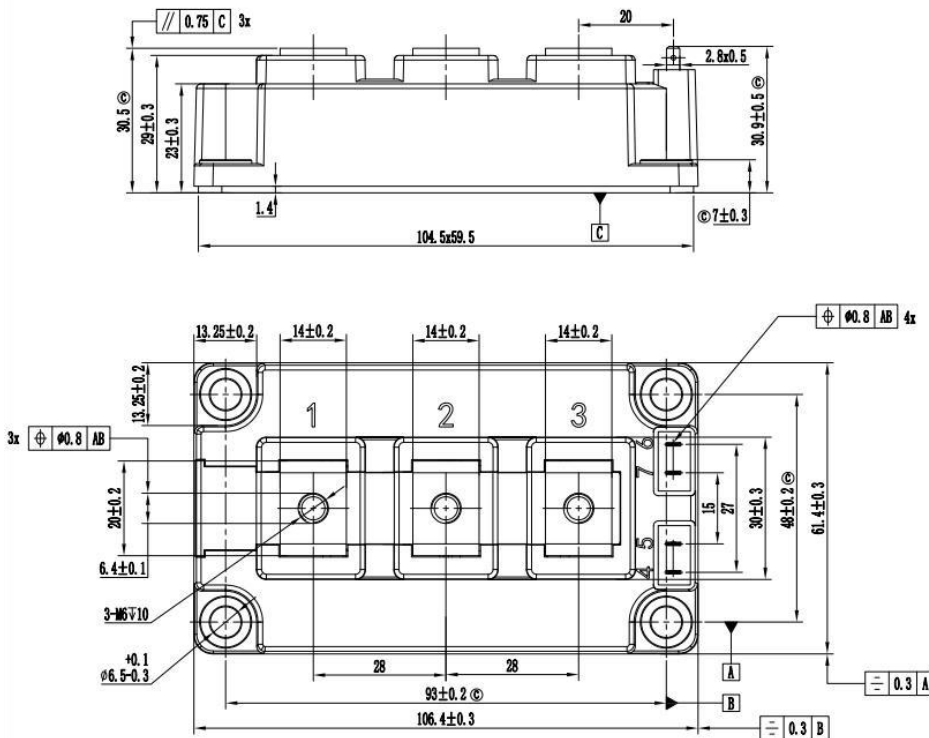


Fig 11. Capacitance characteristic

Circuit Diagram



Package Outlines(Unit: mm)



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